

## STM32WL3RK8 and STM32WL3RKB device errata

## Applicability

This document applies to the part numbers of STM32WL3RK8 and STM32WL3RKB devices and the device variants as stated in this page.

It gives a summary and a description of the device errata, with respect to the device datasheet and reference manual RM0551. Deviation of the real device behavior from the intended device behavior is considered to be a device limitation. Deviation of the description in the reference manual or the datasheet from the intended device behavior is considered to be a documentation erratum. The term “*errata*” applies both to limitations and documentation errata.

**Table 1. Device summary**

Reference	Part numbers
STM32WL3RKx	STM32WL3RK8, STM32WL3RKB

**Table 2. Device variants**

Reference	Silicon revision codes	
	Device marking <sup>(2)</sup>	DIE_ID <sup>(1)</sup>
STM32WL3RKx	B	0x0122

1. Register system controller (SYSCFG) - DIE\_ID register.
2. Refer to the device datasheet for how to identify this code on different types of package.

## 1 Summary of device errata

The following table gives a quick reference to the STM32WL3RK8 and STM32WL3RKB device limitations and their status:

A = workaround available

N = no workaround available

P = partial workaround available

Applicability of a workaround may depend on specific conditions of target application. Adoption of a workaround may cause restrictions to target application. Workaround for a limitation is deemed partial if it only reduces the rate of occurrence and/or consequences of the limitation, or if it is fully effective for only a subset of instances on the device or in only a subset of operating modes, of the function concerned.

**Table 3. Summary of device limitations**

Function	Section	Limitation	Status
			Rev. B
System	2.2.1	MR_SUBG: aborting a TX command may lead to unpredictable behavior in some conditions	A
	2.2.2	MR_SUBG: the data buffer manager threshold status flags can be wrongly reported in some conditions	A
	2.2.3	MR_SUBG: the POSTAMBLE feature does not work with 4-(G)FSK modulation	A
	2.2.4	MR_SUBG: the “whitening before FEC” feature is not functional	A
	2.2.5	MR_SUBG: a continuous wave (CW) transmission cannot be stopped in a specific PA ramp configuration	A
	2.2.6	MR_SUBG: selectivity degradation for some channels	A
	2.2.7	MR_SUBG: CS_F flag is ignored by the sequencer in some cases	A
	2.2.8	Nonbonded GPIOs on VFQFPN32 with default configuration cause increased power consumption	A

## 2 Description of device errata

The following sections describe the errata of the applicable devices with Arm® core and provide workarounds if available. They are grouped by device functions.

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### 2.1 Core

Reference manual and errata notice for the Arm® Cortex®-M0+ core revision r0p1 is available from <http://infocenter.arm.com>.

### 2.2 System

#### 2.2.1 MR\_SUBG: aborting a TX command may lead to unpredictable behavior in some conditions

##### Description

Issuing an SABORT on a TX command may lead to unpredictable event on AHB if it happens during the DBM prefetch phase..

This may lead to an AHB protocol violation.

##### Workaround

The SW must ensure the Radio FSM state reaches the TX state before to send the SABORT command.

#### 2.2.2 MR\_SUBG: the data buffer manager threshold status flags can be wrongly reported in some conditions

##### Description

The TX\_ALMOST\_EMPTY\_x\_F and RX\_ALMOST\_FULL\_x\_F flags can be raised inappropriately if the DATABUFFER\_THRESHOLD is modified between 2 commands.

This may lead to an AHB protocol violation.

##### Workaround

These flags must be cleared before the start of a new command.

#### 2.2.3 MR\_SUBG: the POSTAMBLE feature does not work with 4-(G)FSK modulation

##### Description

The POSTAMBLE pattern is limited to 010101... or 101010... whatever the selected modulation. The HW does not automatically adapt the POSTAMBLE pattern when the 4-(G)FSK modulation is selected (as for the PREAMBLE). This causes a constant frequency deviation during the POSTAMBLE period. This frequency depends on the selected constellation mapping.

##### Workaround

Build the POSTAMBLE by software. This solution requires almost all of the frame to be built by software (from LENGTH, if present in the frame, to the POSTAMBLE):

- Only fixed length configuration can be used (FIX\_VAR\_LEN=0) on transceiver
- The hardware CRC must be disabled (to build in software)
- PCKLEN must be programmed with the full frame length (from LENGTH if present, to POSTAMBLE)

- If the receiver expects the length in the frame, a “LENGTH” bit field can be added by software when building the frame in the data buffer. In this case, the value must not be aligned on the PCKLEN value but on the PAYLOAD value.

## 2.2.4 MR\_SUBG: the “whitening before FEC” feature is not functional

### Description

The HW feature implemented to revert the order of a FEC + whitening sequence to have whitening first and then FEC is not functional. The frame generated when this feature is activated (PCKT\_CTRL[10] = WHIT\_BF\_FEC = 1) does not fit with the expected frame.

The PCKT\_CTRL[10] bit must be kept to 0 as this HW feature cannot be used.

### Workaround

The feature can be built through a mixed SW/HW solution: the whitening (in transmission) / dewhitening (in reception) shall be done by SW while the FEC may be done by HW.

Note:

*CRC and LENGTH information, if required to be present in the frame, shall be managed by SW (PCKT\_CONFIG[2:0] = CRC\_MODE[2:0] = 3'b000 and PCKT\_CONFIG[11] = FIX\_VAR\_LEN = 0), as they both need to be (de)whitened.*

## 2.2.5 MR\_SUBG: a continuous wave (CW) transmission cannot be stopped in a specific PA ramp configuration

### Description

When PA\_CONFIG[14] = PA\_RAMP\_ENABLE bit is set to 1 and PA\_CONFIG[1:0] = PA\_RAMP\_STEP\_WIDTH[1:0] is different from zero, it is not possible to stop a CW transmission through the SABORT command. This limitation does not impact other configurations.

Need to take care of PA\_CONFIG setting before generating a CW transmission.

### Workaround

To modify the power ramp shape (smaller/larger steps) on a CW transmission, the user can modify the data rate parameter. The PA steps are managed as a ratio of a bit period, and so is impacted by the data rate selection. On the other hand, the data rate information has no impact on the CW, as it does not modulate any data.

## 2.2.6 MR\_SUBG: selectivity degradation for some channels

### Description

When the SMPS is on, for carriers which are multiples of fXO/12 or fXO/6, the sensitivity can be strongly degraded. (fXO is the HSE crystal frequency, nominally 48 MHz).

This causes sensitivity degradation.

### Workaround

Several workarounds are possible:

1. Change the crystal frequency in the range 47 MHz-50 MHz.
2. Use the Bypass-on-the-fly feature.
3. Change the SMPS internal clock frequency via the KRM feature.

## 2.2.7 MR\_SUBG: CS\_F flag is ignored by the sequencer in some cases

### Description

The FAST\_RX\_TERM\_F flag is raised 16  $\mu$ s after the Fast Termination counter expiration (to let the radio exit RX state and reach IDLE state). If enough power reaches the antenna during the first 250 ns of this phase, the CS\_F is also raised.

In this scenario, both CS\_F and FAST\_RX\_TERM\_F will be raised, but the CS\_F, that is raised first, shall be ignored, the relevant flag is the FAST\_RX\_TERM\_F.

The programmed sequence is not correctly handled in this case.

#### Workaround

This behavior requires some precaution when building scenarios through the Sequencer. For instance, if the CS\_F is defined as a match event in NextAction1Mask and the FAST\_RX\_TERM\_F is defined as a match event in the other NextAction2Mask in a SeqAction0, there is the need to add the FAST\_RX\_TERM\_F as a match event in the SeqAction1 to move to SeqAction2 (which is the actual state that shall be reached because of the FAST\_RX\_TERM\_F).

### 2.2.8 Nonbonded GPIOs on VFQFPN32 with default configuration cause increased power consumption

#### Description

In the VFQFPN32 configuration, some nonbonded GPIOs are configured upon reset by hardware to push-pull output set to level 0 with the pull-up device enabled. This configuration causes continuous current flow from  $V_{DD1}$  ( $V_{DDIO}$ ) to ground, leading to an additional power consumption of approximately 1.2 mA in Run mode.

The list of nonbonded GPIOs on VFQFPN32 configuration is as follows:

PA4, PA5, PA6, PA12, PA13, PA14, PA15, PB3, PB4, PB5, PB8, PB9, PB10, PB11.

#### Workaround

At startup, reconfigure the nonbonded GPIOs by enabling the pull-down resistor instead of the pull-up resistor.

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## Revision history

**Table 4. Document revision history**

Date	Version	Changes
25-Jul-2025	1	Initial release.

## Contents

<b>1</b>	<b>Summary of device errata.....</b>	<b>2</b>
<b>2</b>	<b>Description of device errata.....</b>	<b>3</b>
<b>2.1</b>	<b>Core .....</b>	<b>3</b>
<b>2.2</b>	<b>System .....</b>	<b>3</b>
<b>2.2.1</b>	<b>MR_SUBG: aborting a TX command may lead to unpredictable behavior in some conditions .....</b>	<b>3</b>
<b>2.2.2</b>	<b>MR_SUBG: the data buffer manager threshold status flags can be wrongly reported in some conditions .....</b>	<b>3</b>
<b>2.2.3</b>	<b>MR_SUBG: the POSTAMBLE feature does not work with 4-(G)FSK modulation .....</b>	<b>3</b>
<b>2.2.4</b>	<b>MR_SUBG: the “whitening before FEC” feature is not functional .....</b>	<b>4</b>
<b>2.2.5</b>	<b>MR_SUBG: a continuous wave (CW) transmission cannot be stopped in a specific PA ramp configuration.....</b>	<b>4</b>
<b>2.2.6</b>	<b>MR_SUBG: selectivity degradation for some channels .....</b>	<b>4</b>
<b>2.2.7</b>	<b>MR_SUBG: CS_F flag is ignored by the sequencer in some cases.....</b>	<b>4</b>
<b>2.2.8</b>	<b>Nonbonded GPIOs on VFQFPN32 with default configuration cause increased power consumption .....</b>	<b>5</b>
<b>Important security notice .....</b>	<b>6</b>	
<b>Revision history .....</b>	<b>7</b>	

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